2134611-1 ACTIVE

Buchanan WireMate

TE Internal #: 2134611-1

Wire-to-Board, 1 Position, Printed Circuit Board / Wire & Cable, 2.48 mm [.097 in] Height, Surface Mount, 24 – 26 AWG, Poke-In

Connectors

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Connectors > Lighting Connectors > Poke-In Connectors











Connector System: Wire-to-Board

Number of Positions: 1

Connector & Contact Terminates To: Printed Circuit Board, Wire & Cable

Connector Height: 2.48 mm [.097 in]

Termination Method to PCB: Surface Mount

Features

Electrical Characteristics

Operating Voltage	250 VDC
Industry Standards	
Compatible With Agency/Standards Products	UL
UL Flammability Rating	UL 94V-0
Compatible With Approved Standards Products	UL E28476
Body Features	
Primary Product Color	Natural
Header Mating Direction	Horizontal
Mechanical Attachment	
PCB Mount Retention	Without
Packaging Features	
Packaging Method	SMT Pocket Tape

Contact Features



PCB Contact Termination Area Plating Material Thickness	3 μm[118.11 μin]
Contact Layout	Inline
Contact Mating Area Plating Material	Tin
PCB Contact Termination Area Plating Material	Tin
Contact Fabrication	Stamped & Formed
Contact Mating Area Plating Material Thickness	3 μm[118 μin]
Contact Current Rating (Max)	3 A, 4 A

Product Type Features

Product Line	Poke-In
Connector System	Wire-to-Board
Connector & Contact Terminates To	Printed Circuit Board, Wire & Cable

Configuration Features

Termination Features

Termination Method to PCB	Surface Mount
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Dimensions

Connector Height	2.48 mm[.097 in]
Wire Size	24 – 26 AWG

Usage Conditions

Operating Temperature Range	-25 – 130 °C[-13 – 266 °F]

Other

EU RoHS Compliance	Compliant
EU ELV Compliance	Compliant

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241)



Doos	not co	ntain	REACH	SV/HC
DOES	not co	ntain	KFACH	SVHU

Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Solder Process Capability

Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts





Customers Also Bought





















Documents

Product Drawings

Micro poke in assembly

English

CAD Files

Customer View Model

ENG_CVM_CVM_2134611-1_J.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2134611-1_J.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2134611-1_J.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

Buchanan WireMate Micro Poke-In

English

BUCHANAN WireMate Connectors Brochure

BUCHANAN WireMate Connectors Brochure

English

Product Specifications

Application Specification

Wire-to-Board, 1 Position, Printed Circuit Board / Wire & Cable, 2.48 mm [.097 in] Height, Surface Mount, 24 – 26 AWG, Poke-In Connectors



Japanese

Agency Approvals

UL Report

English